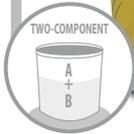


Resilex Ecotech

Two-component epoxy-polyurethane adhesive with low VOC emissions for the installation of wooden flooring.



Fields of application:

- for the application of laminate or solid parquet, lamparquet and any type of floorboards;
- for the application of pre-finished wooden flooring;
- for the application of block flooring;
- for the application of floorboards without using nailing strips;
- for the application on cement screeds, on screeds made with Basecem or Basecem Pronto, on self-levelling products such as Planirapid Autolivellante or Planirapid Autolivellante Maxi, on smoothing plasters such as Rasoplan Tixo, on anhydrite screeds and on heating floors;

Characteristics:

Resilex Ecotech is a highly deformable two-component epoxy-polyurethane adhesive. **Resilex Ecotech** includes micro-charges of spherical aggregate and an epoxy-polytechnic formula with eco-sustainable raw materials, without water. It is ready for walk over in 1-2 days; wait 3-7 days for the smoothing, depending on the temperature. Indicated for an easy and safe wood application in general. Indicated for civil, commercial and industrial applications.

Quality and Environmental Standards:

Resilex Ecotech undergoes constant, careful testing at our laboratories, in compliance with the legislation in force UNI EN ISO 9001/2015.

- for the application on wooden substrates and chipboard panels;
- for the application on existing floors in ceramic, marble or metal sheets;
- professional use only.

Application:

Resilex Ecotech must be prepared mixing **Resilex Ecotech** component A with **Resilex Ecotech** component B with a low speed stirrer, to get a smooth mixture. Check that the substrate complies with norm EN 11493 point 7.3 as for the requirements of curing, integrity, surface sturdiness, dimensional regularity; the humidity content in cement-based screeds must be $\leq 2\%$ and in anhydrite screeds $\leq 0.5\%$ measured with carbide hygrometer. In screeds with higher humidity wait for the screed to dry or apply **Primer SPI**. Apply the obtained mixture using a trowel with large teeth no. 5. Leave a min. 5-mm expansion space between wood and walls. The setting time and the glue's pot life, once mixed with the accelerator, are strictly linked to the room temperature. Apply **Resilex Ecotech** with the specific toothed trowel, ensuring good adhesion. The ideal room temperature must be between $+ 10^{\circ}\text{C}$ and $+30^{\circ}\text{C}$.

Characteristics	Application methods	Consumption
Two-component product Without water and thinners Excellent workability	Toothed trowel	1.0 - 1.5 kg/m ²
		Storage Shelf life of 24 months in the original packages at temperatures above $+5^{\circ}\text{C}$. Do not expose to direct sunlight.

Code	Product	Form and color	Packages	Pallet
167011	Resilex Ecotech	Part A: light brown paste Part B: pale yellow liquid	10 kg	480 kg
167010	Resilex Ecotech	Part A: dark brown paste Part B: pale yellow liquid	10 kg	480 kg

Warning:

- do not lay on gypsum screeds (panels anhydride, magnesian) which are either crumbly or powdery; strengthen first with a diluted coat of **Primer SPI**;
- do not lay directly on substrates with residual humidity over 2.0%;
- in the event of a slight rise in humidity, treat with **Primer SPI**;
- do not lay if the walls and ceiling of the room are not perfectly dry;
- to restore the substrate to a single mass, use **Eposan** to seal cracks and splitting.


Technical and application specifications

Hazard classification as per Directive 99/45/CE:	irritant (part A) corrosive (part B)
Mixing ratio:	part A: part B = 9.4 : 0.6
Mixture pH:	approx. 6
Application temperature:	from +10°C to +30°C
Open time:	approx. 20 minutes
Handling time:	approx. 35 hours
Pot life:	40-50 minutes
Walk-over time:	12-24 hours
Polishing:	24 hours after adhesive is completely dry
Flexibility:	excellent
Resistance to damp and ageing:	excellent
Temperature resistance:	from -30°C to + 50°C
Harmonised customs code:	39095000

Measurement of data at 23°C/50% Residual Humidity and no ventilation. The data may be considerably modified by the conditions of use.